

Silicon N-Channel Power MOSFET

Description

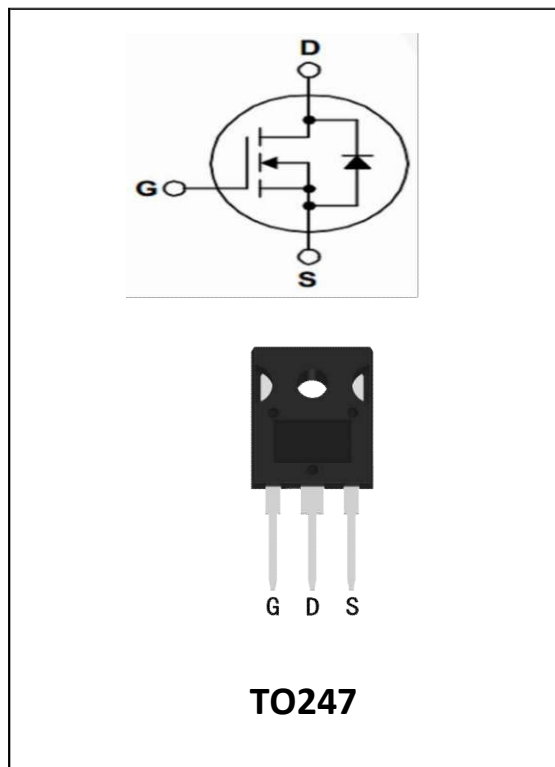
IRFP260N the silicon N-channel Enhanced MOSFETs, is obtained by advanced MOSFET technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor is suitable device for SMPS, high speed switching and general purpose applications.

General Features

- ① $V_{DS}=200V$, $R_{dson}<50m\Omega$ @ $V_{GS}=10V$, $I_D=50A$ (Typ:40m Ω)
- ② Fast switching
- ③ 100% avalanche tested
- ④ Improved dv/dt capability

Application

- ① Switch Mode Power Supply (SMPS)
- ② Uninterruptible Power Supply (UPS)
- ③ Power Factor Correction (PFC)



Package Marking And Ordering Information:

Ordering Codes	Package	Product Code	Packing
IRFP260N	TO-247	IRFP260N	Tube

Absolute Maximum Ratings TC = 25°C, unless otherwise noted

Parameter	Symbol	Value	Unit
		TO-247	
Drain-Source Voltage	V_{DSS}	200	V
Continuous Drain Current	I_D	50	A
Pulsed Drain Current(note2)	I_{DM}	200	A
Gate-Source Voltage	V_{GSS}	± 20	V
Single Pulse Avalanche Energy (note2)	E_{AS}	780	mJ
Avalanche Current (note1)	I_{AR}	39.5	V/ns
Repetitive Avalanche Energy (note1)	E_{AR}	468	W
Power Dissipation (TC = 25°C)	P_D	250	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 175	°C

Thermal Resistance

Parameter	Symbol	Value		Unit
		TO-247		
Thermal Resistance, Junction-to-Case	R_{thJC}	0.5		°C/W
Thermal Resistance, Junction-to-Ambient	R_{thJA}	45		

Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	200	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 200V, V_{GS} = 0V, T_J = 25^\circ\text{C}$	--	--	1	μA
Gate-Source Leakage	I_{GSS}	$V_{GS} = +20V, V_{DS} = 0V$	--	--	100	nA
		$V_{GS} = -20V, V_{DS} = 0V$	--	--	-100	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.0	--	4.0	V
Drain-Source On-Resistance (Note3)	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 25A$	--	40	50	m Ω
Input Capacitance	C_{iss}	$V_{GS} = 0V,$ $V_{DS} = 25V,$ $f = 1.0\text{MHz}$	--	3538	--	pF
Output Capacitance	C_{oss}		--	657	--	
Reverse Transfer Capacitance	C_{rss}		--	280	--	
Total Gate Charge	Q_g	$V_{DD} = 160V,$ $I_D = 25A,$ $V_{GS} = 0 \text{ to } 10V$	--	244	--	nC
Gate-Source Charge	Q_{gs}		--	16	--	
Gate-Drain Charge	Q_{gd}		--	144	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 100V,$ $I_D = 25A,$ $V_{GS} = 10V$ $R_G = 25\Omega$	--	53	--	ns
Turn-on Rise Time	t_r		--	65	--	
Turn-off Delay Time	$t_{d(off)}$		--	689	--	
Turn-off Fall Time	t_f		--	230	--	
Continuous Body Diode Current	I_S	$T_C = 25^\circ\text{C}$	--	--	50	A
Pulsed Diode Forward Current	I_{SM}		--	--	200	
Body Diode Voltage	V_{SD}	$T_J = 25^\circ\text{C}, I_{SD} = 25A, V_{GS} = 0V$	--	--	1.5	V
Reverse Recovery Time	t_{rr}	$V_{GS} = 0V, I_S = 25A,$ $d_{IF}/dt = 100A/\mu s$	--	208	--	ns
Reverse Recovery Charge	Q_{rr}		--	2.04	--	μC

Notes

1.Repetitive Rating: Pulse width limited by maximum junction temperature

 2. $I_{AS} = 30A, V_{DD} = 30V, R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$

 Pulse Test: Pulse width $\leq 300\mu s$, Duty Cycle $\leq 1\%$

Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics ($T_J = 25^\circ\text{C}$)

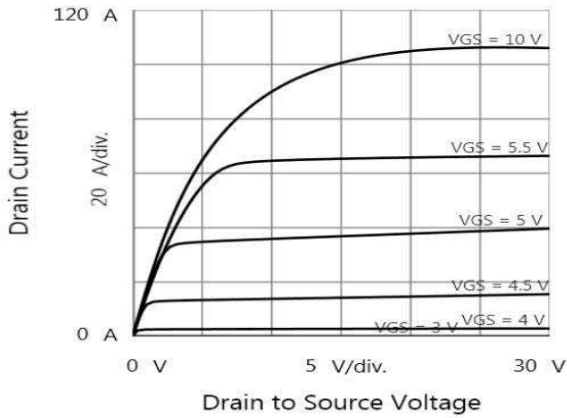


Figure 2. Transfer Characteristics

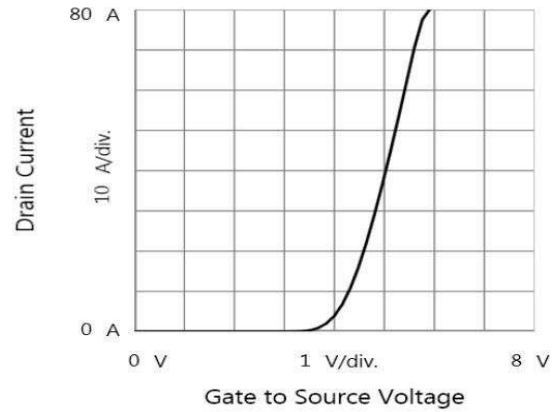


Figure 3. Maximum Continuous Drain Current vs Case Temperature

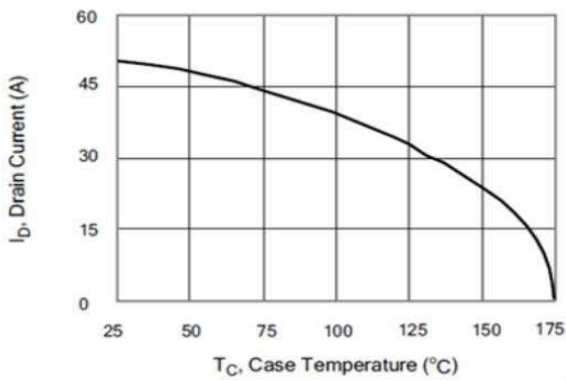


Figure 4. Drain to Source Voltage vs. Gate to Source Voltage

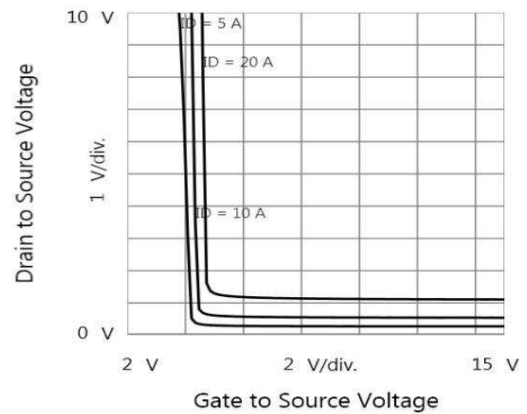


Figure 5. Typical Breakdown Voltage vs Junction Temperature

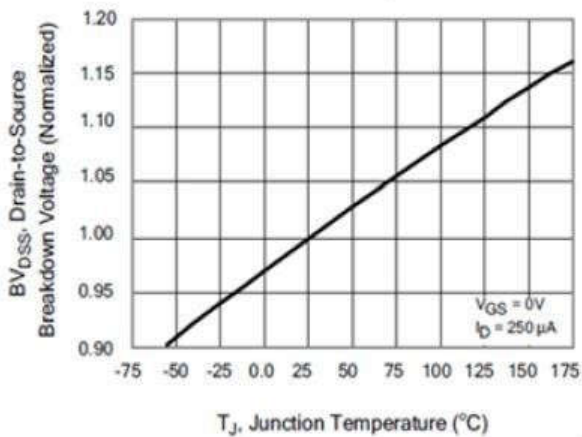
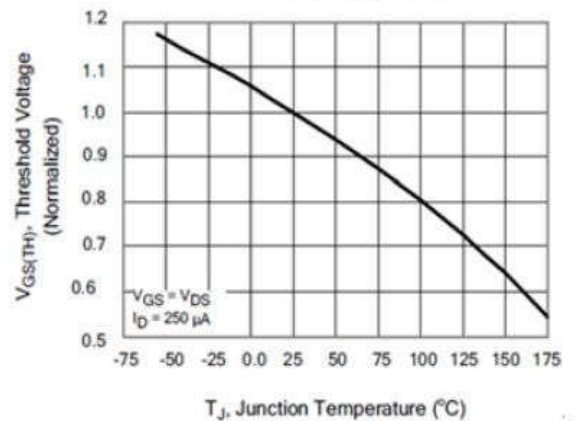


Figure 6. Typical Threshold Voltage vs Junction Temperature



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Capacitance

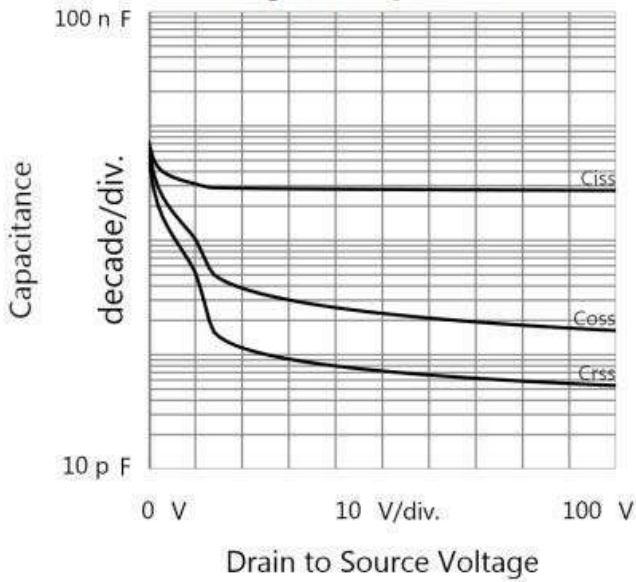


Figure 8. Gate Charge

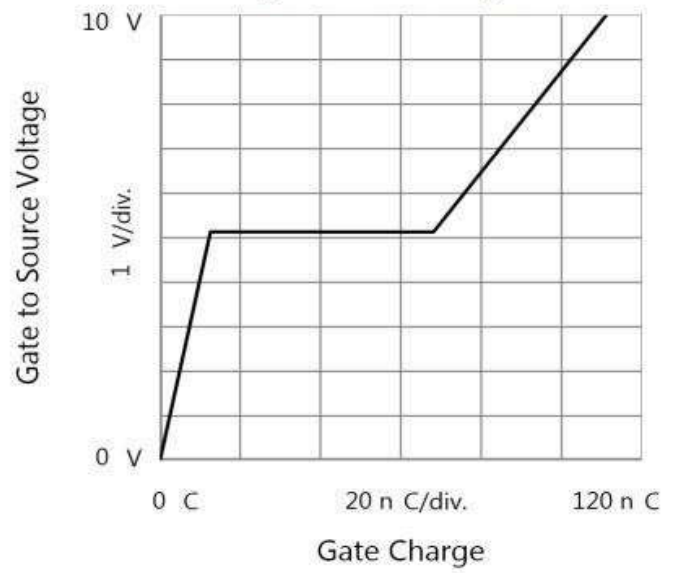


Figure 9. Transient Thermal Impedance
TO-247, TO-3P

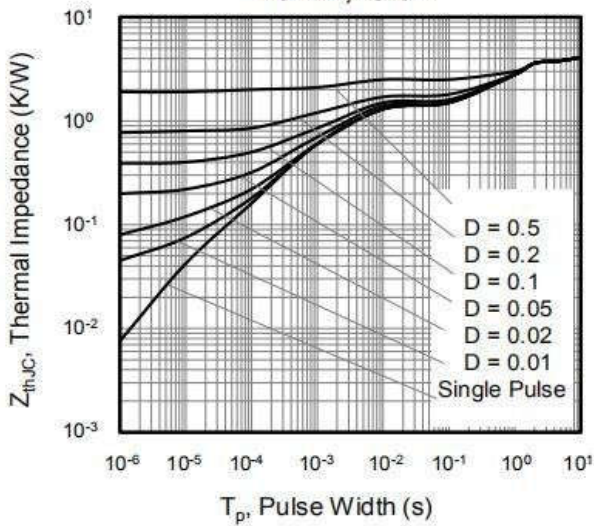


Figure 10. Maximum Forward Bias Safe
Operating Area

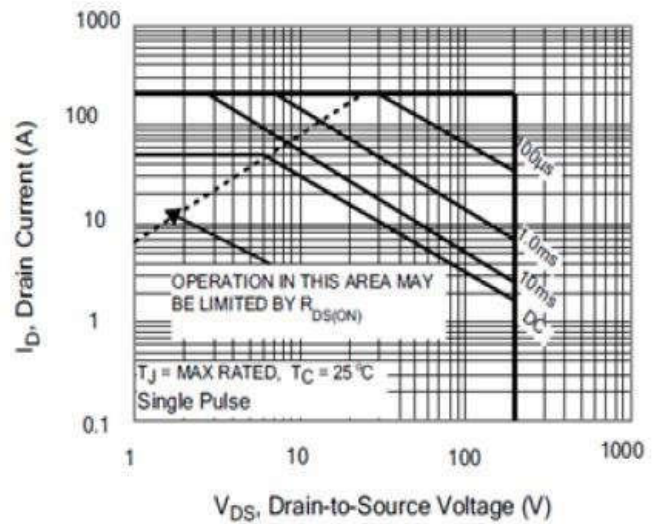


Figure A: Gate Charge Test Circuit and Waveform

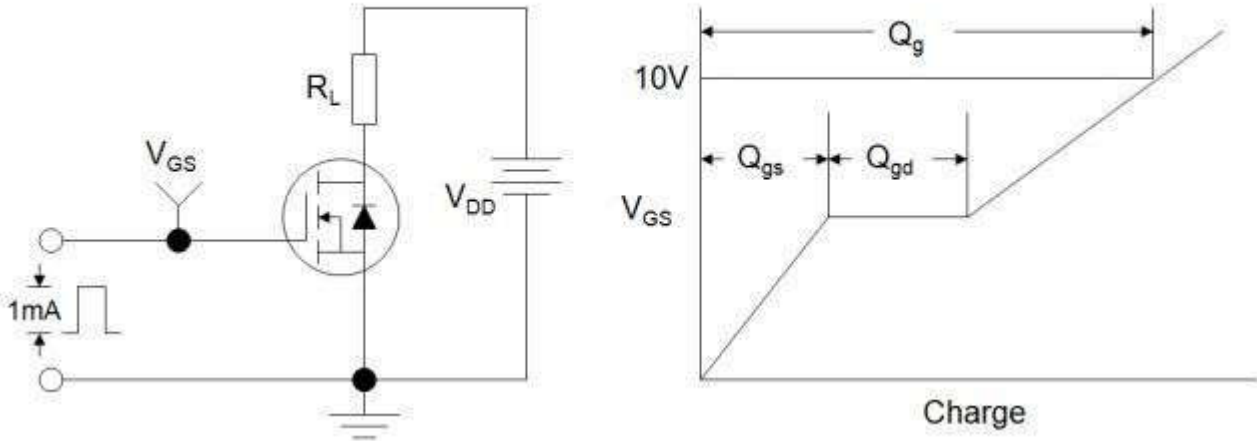


Figure B: Resistive Switching Test Circuit and Waveform

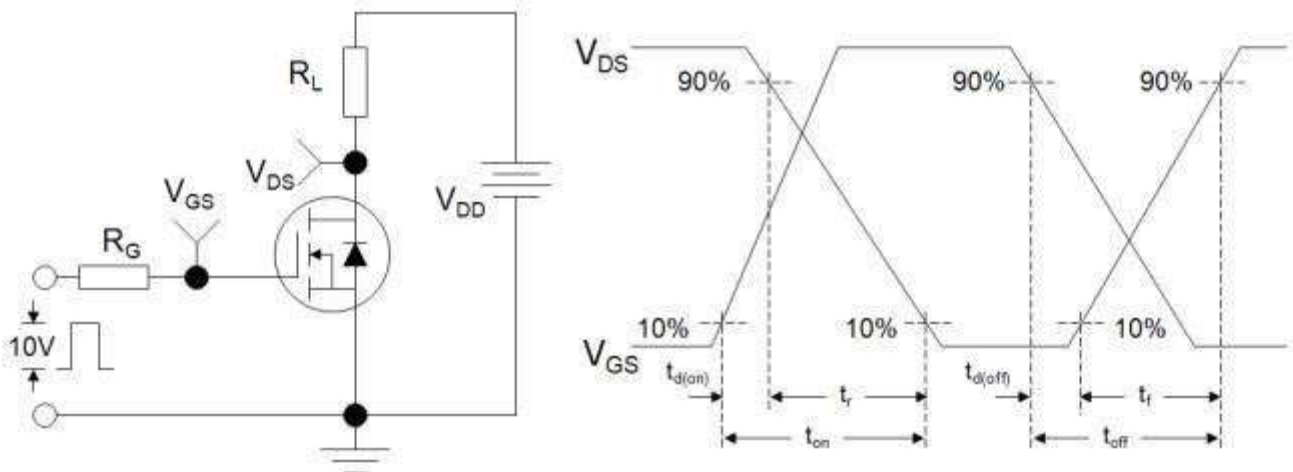
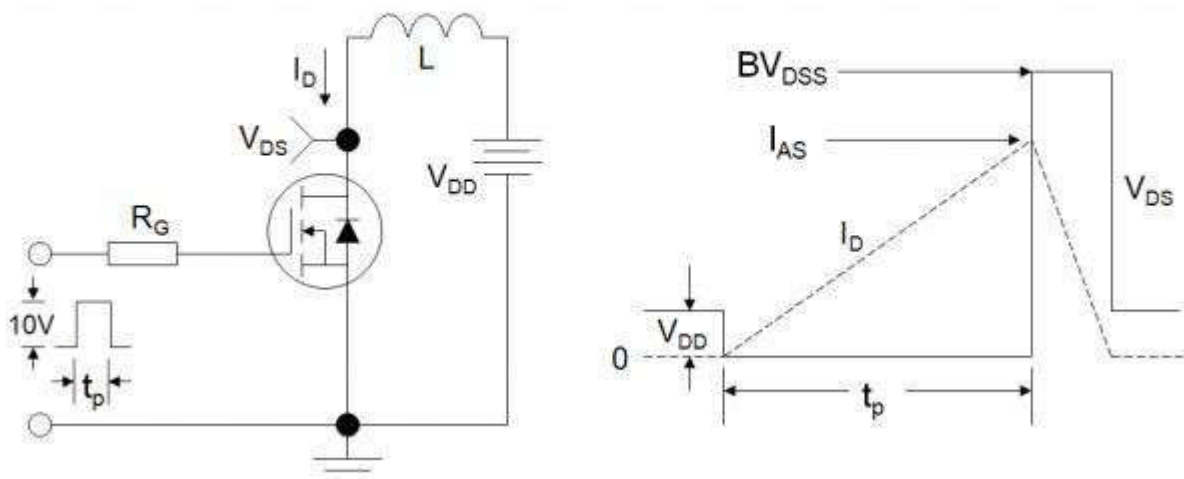
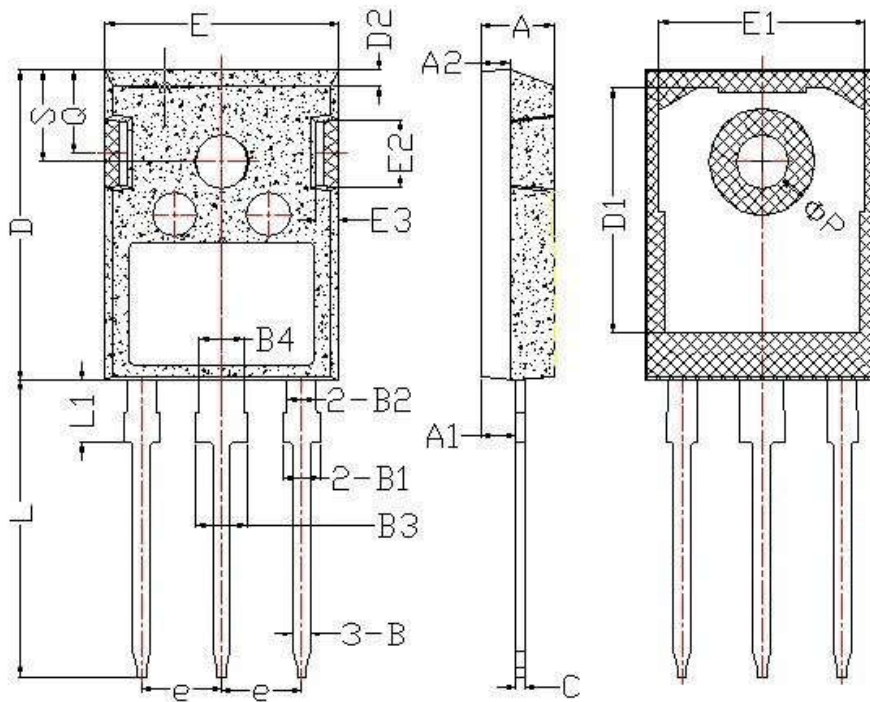


Figure C: Unclamped Inductive Switching Test Circuit and Waveform



Package Description



Items	Values(mm)	
	MIN	MAX
A	4.6	5.2
A1	2,2	2.6
B	0.9	1.4
B1	1.75	2.35
B2	1.75	2.15
B3	2.8	3.35
B4	2.8	3.15
C	0.5	0.7
D	20.60	21.30
D1	16	18
E	15.5	16.10
E1	13	14.7
E2	3.80	5.3
E3	0.8	2.60
e	5.2	5.7
L	19	20.5
L1	3.9	4.6
ΦP	2.5	3.70
Q	5.2	6.00
S	5.8	6.6

TO-247 Package

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NOTE:

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. Please do not exceed the absolute maximum ratings of the device when circuit designing.
2. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
3. MOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. Shenzhen Minos reserves the right to make changes in this specification sheet and is subject to change without prior notice.

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